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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Product Status Active Core Processor XCore Core Size 32-Bit 32-Core Speed 4000MIPS Connectivity USB Peripherals - Number of I/O 208 Program Memory Size - Program Memory Type ROMIess EEPROM Size - RAM Size 512K x 8 Voltage - Supply (Vcc/Vdd) 0.95V ~ 3.6V Data Converters - Oscillator Type External Operating Temperature 0°C ~ 70°C (TA) Mounting Type Surface Mount Package / Case 324-FBGA (15x15) Purchase URL https://www.e-xfl.com/product-detail/xmos/xu232-512-fb324-c40		Details
Core Processor XCore Core Size 32-Bit 32-Core Speed 4000MIPS Connectivity USB Peripherals - Number of I/O 208 Program Memory Size - Program Memory Type ROMIess EEPROM Size - RAM Size 512K x 8 Voltage - Supply (Vcc/Vdd) 0.95V ~ 3.6V Data Converters - Oscillator Type External Operating Temperature 0°C ~ 70°C (TA) Mounting Type Surface Mount Package / Case 324-FBGA Supplier Device Package 324-FBGA (15x15)		
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Supplier Device Package 324-FBGA (15x15)		Mounting Type
Purchase LIPI		Package / Case
Purchase URL https://www.e-xfl.com/product-detail/xmos/xu232-512-fb324-c40		Supplier Device Package
	-512-fb324-c40	Purchase URL

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



xCORE-200 XU/XUF USB

A new generation of high performance USB-enabled multicore microcontrollers



FEATURES

Multicore compute with up to 1000MIPS (8 core) and 4000MIPS (32 core) performance.

Hardware ResponseTM ports provide flexible, high-performance configurable I/O capability.

Integrated USB 2.0 PHY for highand full-speed host and device operation.

Up to 1024KB on-board memory for demanding applications.

Embedded flash option – up to 2048KB on-board.

Free software library support to implement your exact mix of peripherals.

Easy to use with our free xTIMEcomposer Studio TM tools.

The xCORE-200TM USB family of devices (XU and XUF) extends the popular xCORETM architecture to provide increased performance, memory footprint and flexibility for the most demanding applications.

xCORE-200 XU/XUF integrates up to two USB 2.0 PHYs (host or device) and implements a dual-issue processor pipeline to boost peak compute performance up to 4000MIPS and 2000MMACS.

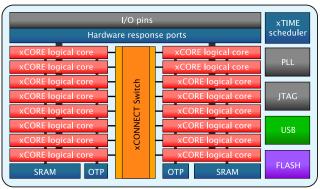
Up to 1024KB on-chip SRAM memory is available. Each member of the xCORE-200 family has an embedded flash option for applications.

The flexible Hardware Response ports are bonded out to I/O pins as 1 bit, 4 bit, 8 bit, 16 bit and 32 bit ports, and provide support for serialized and buffered data transfer. Up to 176 general purpose I/O are available for user configuration.

xCORE-200 is supported by the advanced XMOS xTIMEcomposer StudioTM development environment, and a wide range of microcontroller and application libraries are freely downloadable from www.xmos.com



Unlike conventional microcontrollers, xCORE-200 multicore microcontrollers execute multiple real-time tasks simultaneously. The xCORE-200 XU/XUF family includes devices with 8, 10, 12, 16, 24 and 32 cores. Each logical core can execute computational code, advanced DSP code, control software (including logic decisions and executing a state machine) or drive and sample data on the I/O ports.



xCORE-200™ XUF216

The devices include xTIME scheduling hardware

that performs functions similar to those of an RTOS, and hardware that connects the cores directly to I/O pins, ensuring fast processing and extremely low latency. The xTIME scheduler eliminates the use of interrupts and ensures deterministic operation.

The on-chip SRAM can be accessed in a single cycle, reducing shared memory requirements by passing data directly between tasks executing on logical cores. Similarly the xCONNECT switch is a high-speed network allowing all cores to communicate with each other.

xCORE-200 multicore microcontrollers include an area of one-time programmable memory with AES support to allow the implementation of secure boot functionality.

ORDERING INFORMATION

xCORE-200 XU/XUF devices are available in a range of resource densities, packages, performance and temperature grades depending on your needs.

					Package [GPIOs]						
Family	Cores	RAM (KB)	Flash (KB)	USB PHYs	TQ64	TQ128	FB236	FB374			
XU208	8	128 256	-	1	XU208-128-TQ64 [33] XU208-256-TQ64 [33]	XU208-128-TQ128 [33] XU208-256-TQ128 [33]					
XU210	10	256 512	-	1		XU210-256-TQ128 [81] XU210-512-TQ128 [81]	XU210-256-FB236 [128] XU210-512-FB236 [128]				
XU212	12	256 512	-	1		XU212-256-TQ128 [81] XU212-512-TQ128 [81]	XU212-256-FB236 [128] XU212-512-FB236 [128]				
XU216	16	256 512	-	1		XU216-256-TQ128 [81] XU216-512-TQ128 [81]	XU216-256-FB236 [128] XU216-512-FB236 [128]				
XU224	24	512 1024	-	2				XU224-512-FB374 [176] XU224-1024-FB374 [176]			
XU232	32	512 1024	-	2				XU232-512-FB374 [176] XU232-1024-FB374 [176]			
XUF208	8	128 256	1024	1	XUF208-128-TQ64 [33] XUF208-256-TQ64 [33]	XUF208-128-TQ128 [33] XUF208-256-TQ128 [33]					
XUF210	10	256 512	2048	1			XUF210-256-FB236 [128] XUF210-512-FB236 [128]				
XUF212	12	256 512	2048	1			XUF212-256-FB236 [128] XUF212-512-FB236 [128]				
XUF216	16	256 512	2048	1			XUF216-256-FB236 [128] XUF216-512-FB236 [128]				
XUF224	24	512 1024	2048	2				XUF224-512-FB374 [176] XUF224-1024-FB374 [176]			
XUF232	32	512 1024	2048	2				XUF232-512-FB374 [176] XUF232-1024-FB374 [176]			

For pricing and availability, please visit the XMOS website for a list of our distributors. www.xmos.com/distributors.

